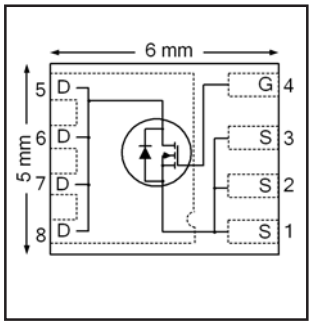
HEXFET® Power MOSFET

V_{DS}	30	V
$V_{GS\ max}$	± 20	V
$R_{DS(on)\ max}$ (@V_{GS} = 10V)	12.8	mΩ
(@V_{GS} = 4.5V)	19.9	
$Q_{g\ typ.}$	4.7	nC
I_D (@$T_{c(Bottom)}$ = 25°C)	16.2⑦	A





PQFN 5X6 mm

Applications

- Control MOSFET for high frequency buck converters

Features and Benefits

Features		Benefits
Low Thermal Resistance to PCB (< 4.7°C/W)	results in ⇒	Enable better thermal dissipation
Low Profile (<1.2mm)		Increased Power Density
Industry-Standard Pinout		Multi-Vendor Compatibility
Compatible with Existing Surface Mount Techniques		Easier Manufacturing
RoHS Compliant Containing no Lead, no Bromide and no Halogen		Environmentally Friendlier
MSL1, Consumer Qualification		Increased Reliability

Orderable part number	Package Type	Standard Pack		Note
		Form	Quantity	
IRFH8337TRPBF	PQFN 5mm x 6mm	Tape and Reel	4000	
~~IRFH8337TR2PBF~~	~~PQFN 5mm x 6mm~~	~~Tape and Reel~~	~~400~~	EOL notice #259

Absolute Maximum Ratings

	Parameter	Max.	Units
V_{DS}	Drain-to-Source Voltage	30	V
V_{GS}	Gate-to-Source Voltage	± 20	
I_D @ T_A = 25°C	Continuous Drain Current, V_{GS} @ 10V	12	A
I_D @ T_A = 70°C	Continuous Drain Current, V_{GS} @ 10V	9.7	
I_D @ $T_{C(Bottom)}$ = 25°C	Continuous Drain Current, V_{GS} @ 10V	35⑥⑦	
I_D @ $T_{C(Bottom)}$ = 100°C	Continuous Drain Current, V_{GS} @ 10V	22⑥⑦	
I_D @ T_C = 25°C	Continuous Drain Current, V_{GS} @ 10V (Source Bonding Technology Limited)	16.2⑦	
I_{DM}	Pulsed Drain Current ①	65	
P_D @T_A = 25°C	Power Dissipation ⑤	3.2	W
P_D @$T_{C(Bottom)}$ = 25°C	Power Dissipation ⑤	27	
	Linear Derating Factor ⑤	0.026	W/°C
T_J T_{STG}	Operating Junction and Storage Temperature Range	-55 to + 150	°C

Notes ① through ⑦ are on page 9

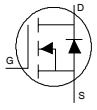
Static @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	30	—	—	V	V_{GS} = 0V, I_D = 250µA
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	—	0.025	—	V/°C	Reference to 25°C, I_D = 1.0mA
$R_{DS(on)}$	Static Drain-to-Source On-Resistance	—	10.3	12.8	mΩ	V_{GS} = 10V, I_D = 16.2A ③
		—	15.8	19.9		V_{GS} = 4.5V, I_D = 13A ③
$V_{GS(th)}$	Gate Threshold Voltage	1.35	1.8	2.35	V	V_{DS} = V_{GS}, I_D = 25µA
$\Delta V_{GS(th)}$	Gate Threshold Voltage Coefficient	—	-6.0	—	mV/°C	
I_{DSS}	Drain-to-Source Leakage Current	—	—	1.0	µA	V_{DS} = 24V, V_{GS} = 0V
		—	—	150		V_{DS} = 24V, V_{GS} = 0V, T_J = 125°C
I_{GSS}	Gate-to-Source Forward Leakage	—	—	100	nA	V_{GS} = 20V
	Gate-to-Source Reverse Leakage	—	—	-100		V_{GS} = -20V
gfs	Forward Transconductance	31	—	—	S	V_{DS} = 10V, I_D = 16.2A
Q_g	Total Gate Charge	—	10	—	nC	V_{GS} = 10V, V_{DS} = 15V, I_D = 16.2A
Q_g	Total Gate Charge	—	4.7	—	nC	V_{DS} = 15V V_{GS} = 4.5V I_D = 16.2A
Q_{gs1}	Pre-Vth Gate-to-Source Charge	—	1.6	—		
Q_{gs2}	Post-Vth Gate-to-Source Charge	—	0.7	—		
Q_{gd}	Gate-to-Drain Charge	—	1.4	—		
Q_{godr}	Gate Charge Overdrive	—	1.0	—		
Q_{sw}	Switch Charge (Q_{gs2} + Q_{gd})	—	2.1	—		
Q_{oss}	Output Charge	—	4.2	—	nC	V_{DS} = 16V, V_{GS} = 0V
R_G	Gate Resistance	—	1.6	—	Ω	
$t_{d(on)}$	Turn-On Delay Time	—	6.4	—	ns	V_{DD} = 15V, V_{GS} = 4.5V I_D = 16.2A R_G=1.8Ω
t_r	Rise Time	—	12	—		
$t_{d(off)}$	Turn-Off Delay Time	—	5.7	—		
t_f	Fall Time	—	4.1	—		
C_{iss}	Input Capacitance	—	790	—	pF	V_{GS} = 0V V_{DS} = 10V f = 1.0MHz
C_{oss}	Output Capacitance	—	180	—		
C_{rss}	Reverse Transfer Capacitance	—	69	—		

Avalanche Characteristics

	Parameter	Typ.	Max.	Units
E_{AS}	Single Pulse Avalanche Energy ②	—	28	mJ
I_{AR}	Avalanche Current ①	—	16.2	A

Diode Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
I_S	Continuous Source Current (Body Diode)	—	—	16.2	A	MOSFET symbol showing the integral reverse p-n junction diode. 
I_{SM}	Pulsed Source Current (Body Diode) ①	—	—	65		
V_{SD}	Diode Forward Voltage	—	—	1.0	V	T_J = 25°C, I_S = 16.2A, V_{GS} = 0V ③
t_{rr}	Reverse Recovery Time	—	12	18	ns	T_J = 25°C, I_F = 16.2A, V_{DD} = 15V
Q_{rr}	Reverse Recovery Charge	—	17	26	nC	di/dt = 390 A/µs ③
t_{on}	Forward Turn-On Time	Time is dominated by parasitic Inductance				

Thermal Resistance

	Parameter	Typ.	Max.	Units
$R_{\theta JC}$ (Bottom)	Junction-to-Case ④	—	4.7	°C/W
$R_{\theta JC}$ (Top)	Junction-to-Case ④	—	40	
$R_{\theta JA}$	Junction-to-Ambient ⑤	—	39	
$R_{\theta JA}$ (<10s)	Junction-to-Ambient ⑤	—	26	

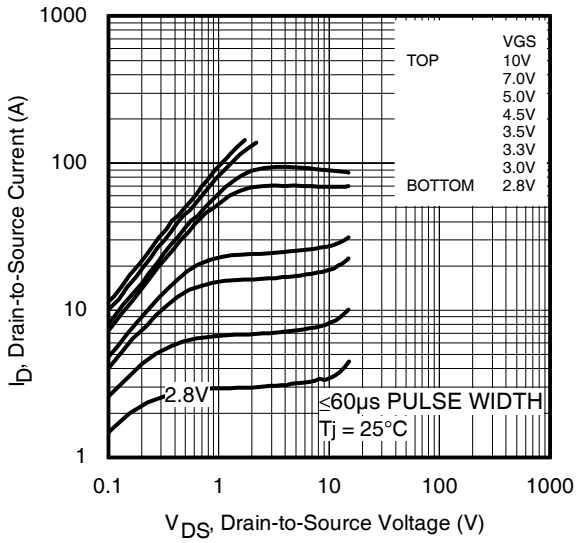


Fig 1. Typical Output Characteristics

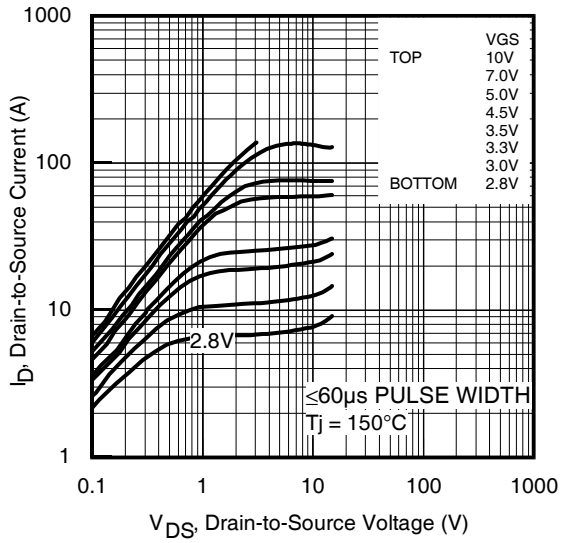


Fig 2. Typical Output Characteristics

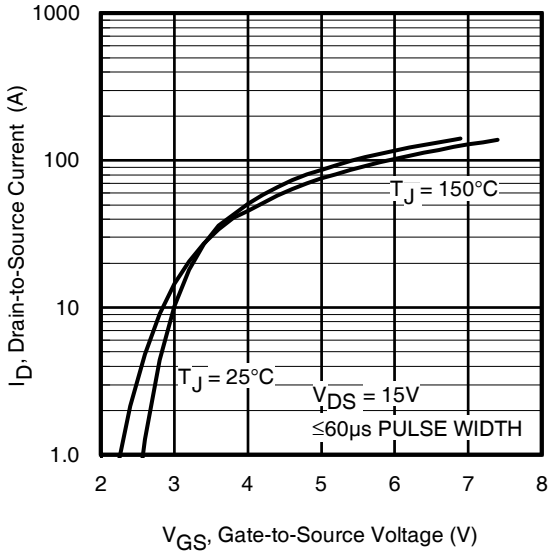


Fig 3. Typical Transfer Characteristics

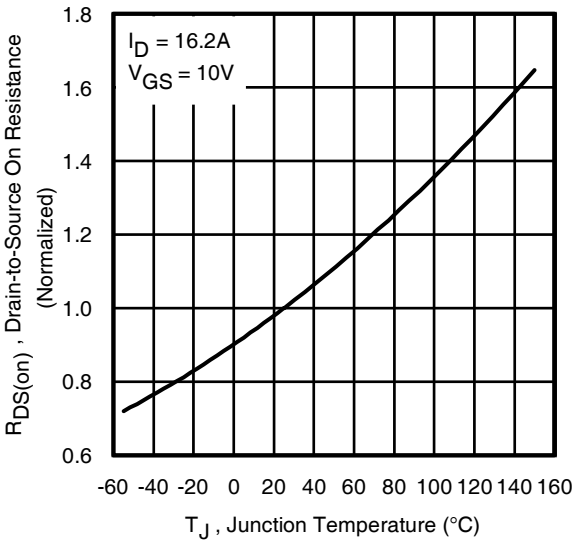


Fig 4. Normalized On-Resistance vs. Temperature

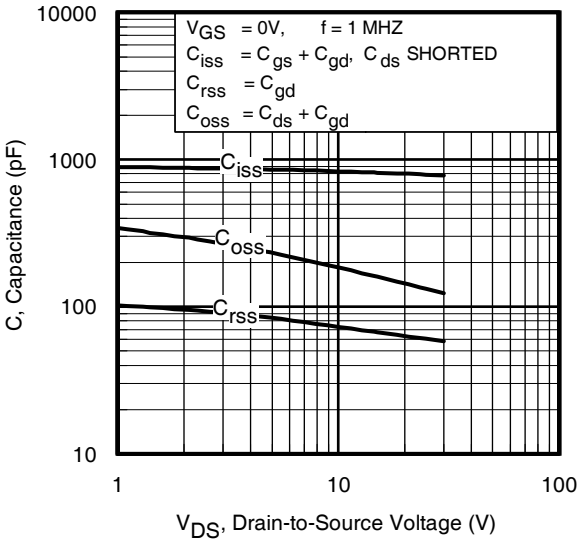


Fig 5. Typical Capacitance vs.Drain-to-Source Voltage

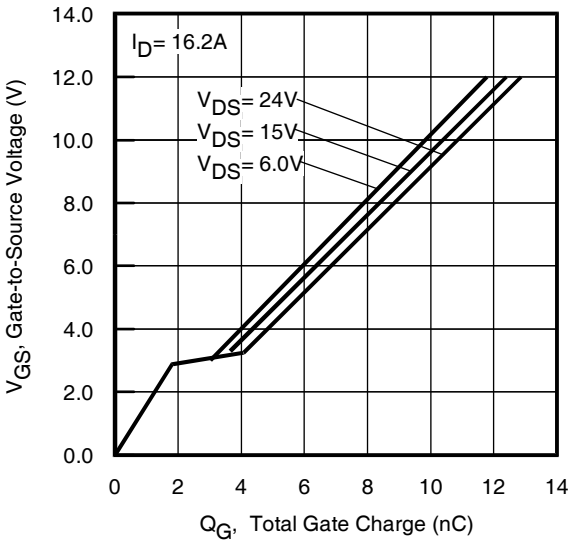


Fig 6. Typical Gate Charge vs.Gate-to-Source Voltage

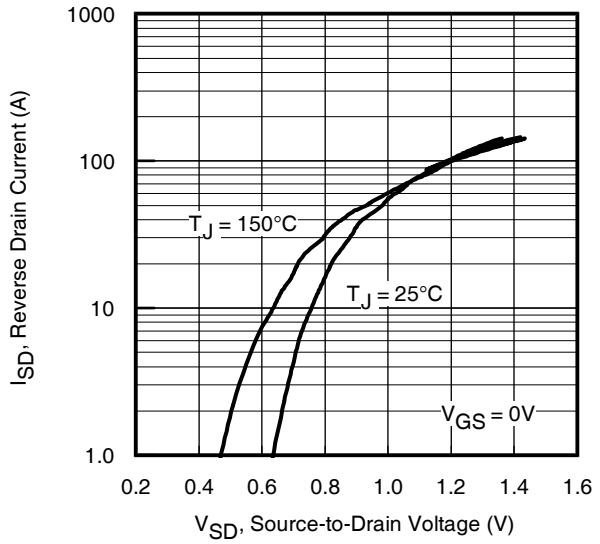


Fig 7. Typical Source-Drain Diode Forward Voltage

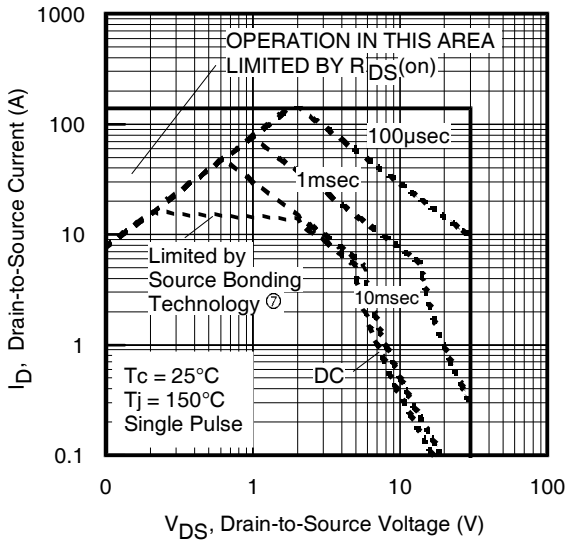


Fig 8. Maximum Safe Operating Area

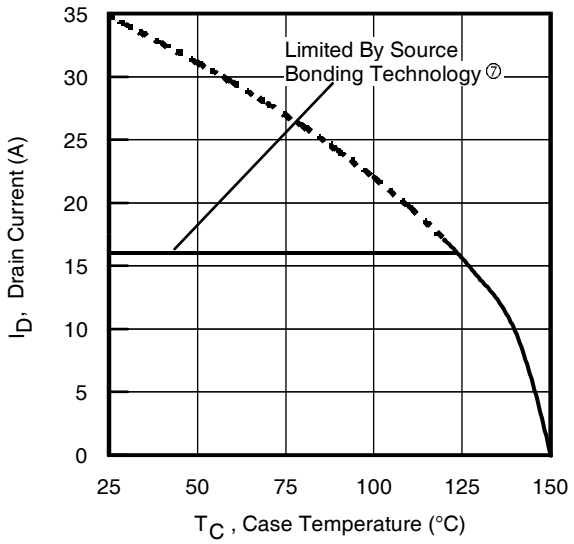


Fig 9. Maximum Drain Current vs. Case (Bottom) Temperature

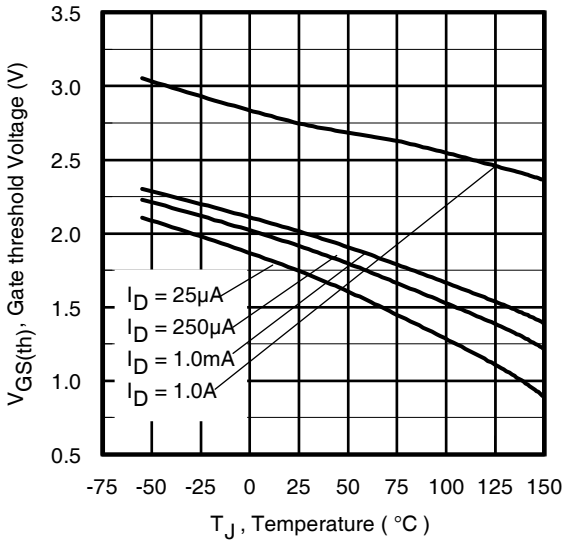


Fig 10. Threshold Voltage vs. Temperature

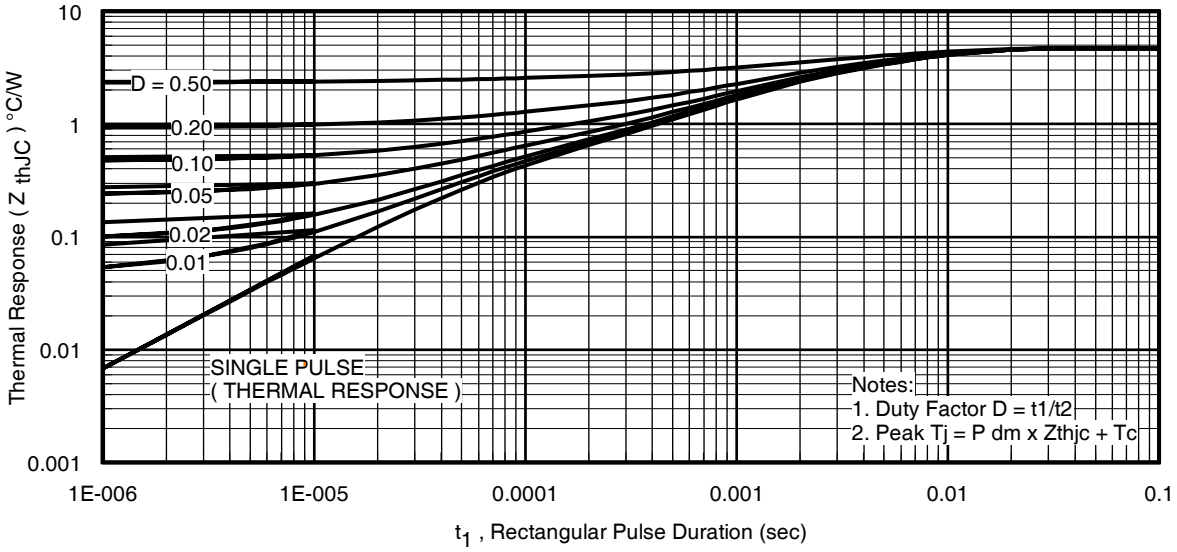


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case (Bottom)

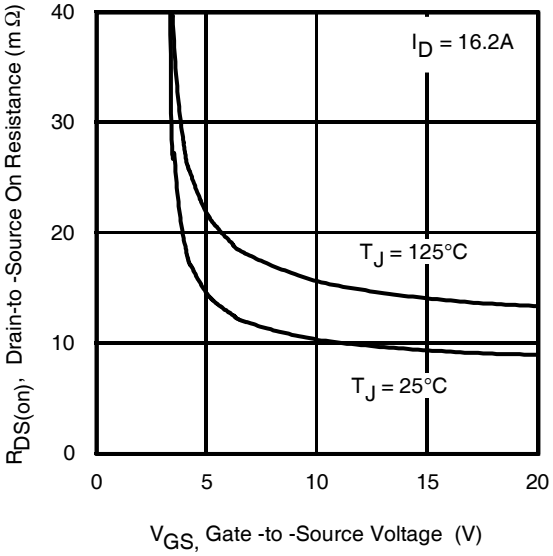


Fig 12. On-Resistance vs. Gate Voltage

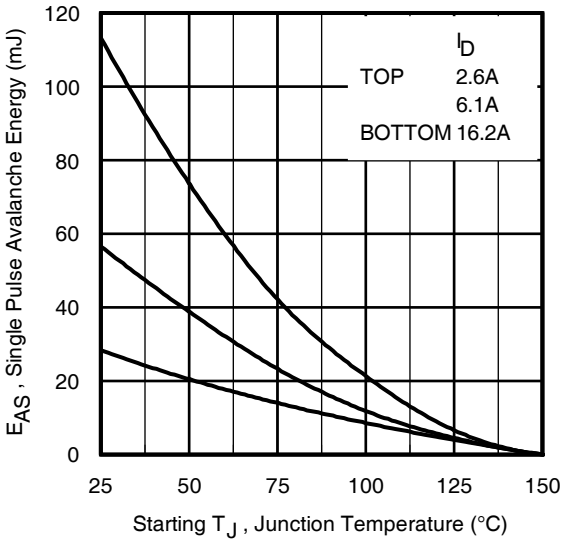


Fig 13. Maximum Avalanche Energy vs. Drain Current

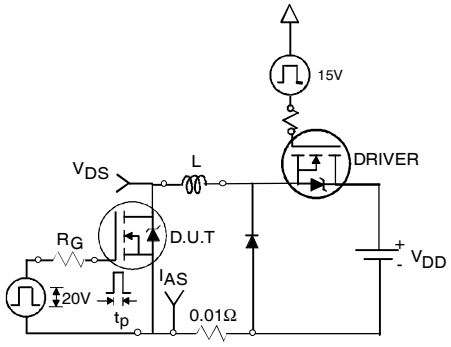


Fig 14a. Unclamped Inductive Test Circuit

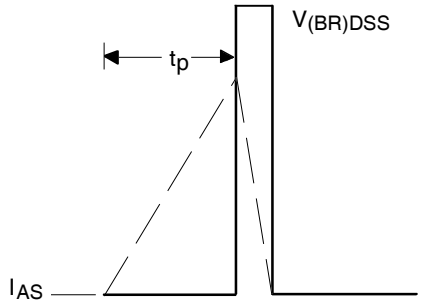


Fig 14b. Unclamped Inductive Waveforms

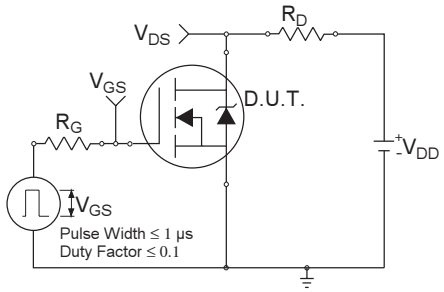


Fig 15a. Switching Time Test Circuit

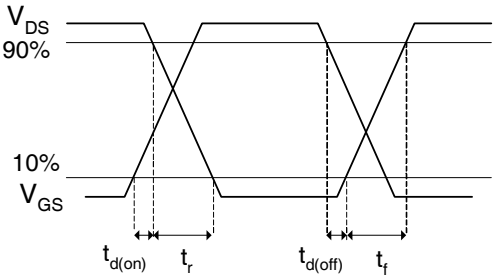


Fig 15b. Switching Time Waveforms

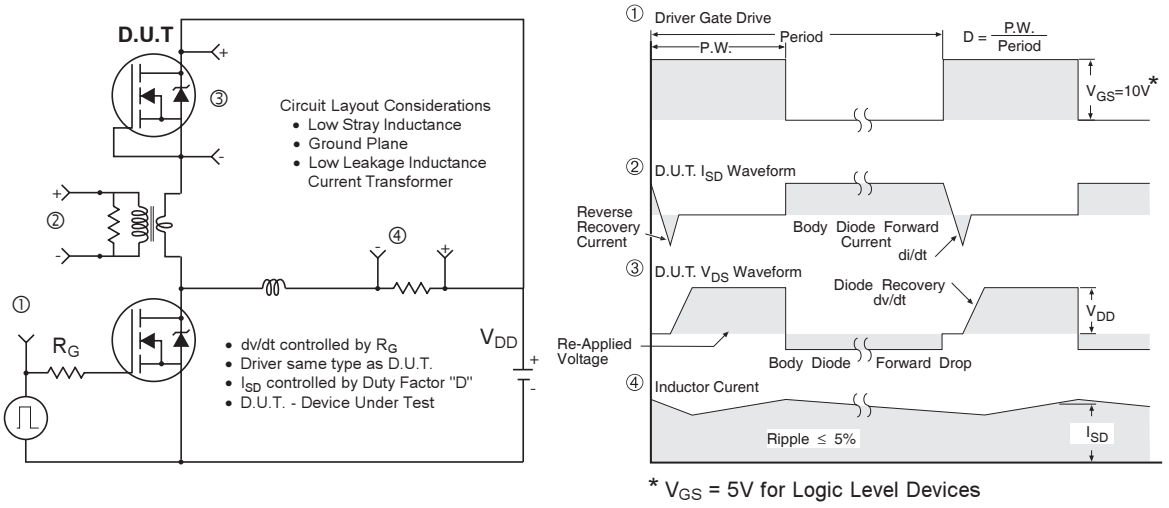


Fig 16. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET® Power MOSFETs

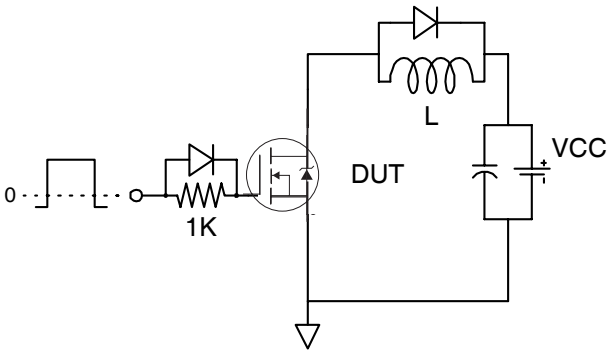


Fig 17. Gate Charge Test Circuit

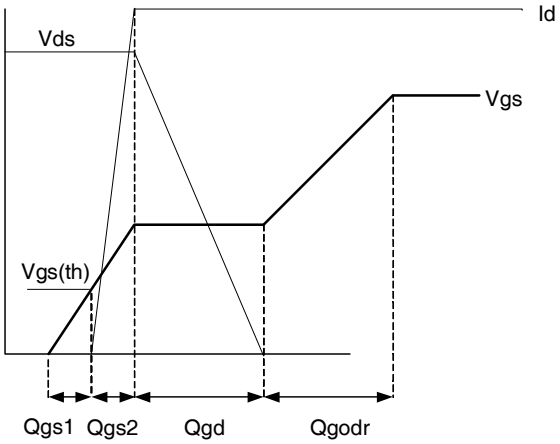
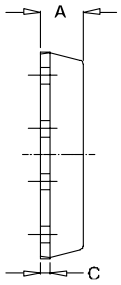
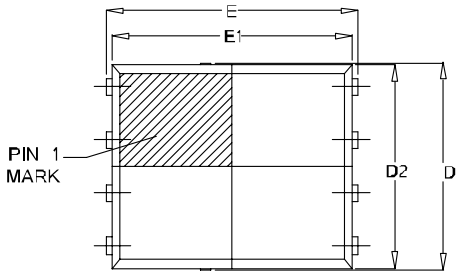


Fig 18. Gate Charge Waveform

PQFN 5x6 Outline "E" Package Details

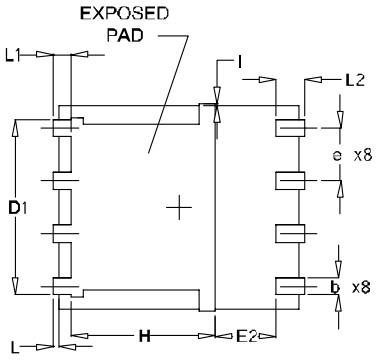


SIDEVIEW



TOP VIEW

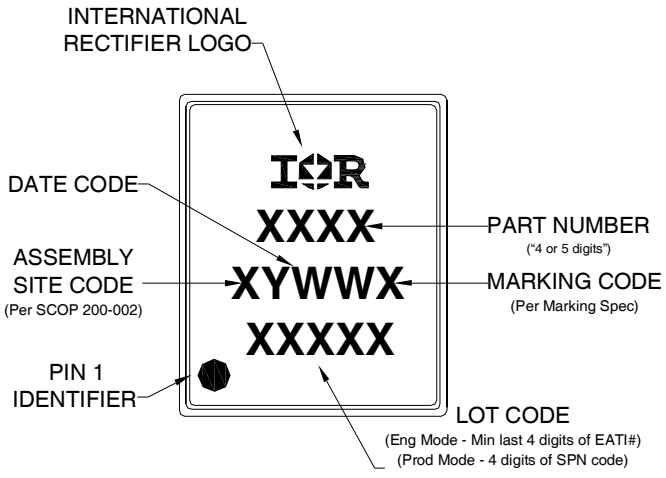
SYMBOL	OUTLINE PQFN 5X6E		
	MIN.	NOM	MAX.
A	0.90	1.03	1.17
b	0.33	0.41	0.48
C	0.20	0.25	0.35
D	4.80	4.98	5.15
D1	3.91	4.11	4.31
D2	4.80	4.90	5.00
E	5.90	6.02	6.15
E1	5.65	5.75	5.85
E2	1.10	—	—
e	1.27 BSC		
L	0.05	0.15	0.25
L1	0.38	0.44	0.50
L2	0.51	0.68	0.86
H	3.32	3.45	3.58
I	—	—	0.18



BOTTOM VIEW

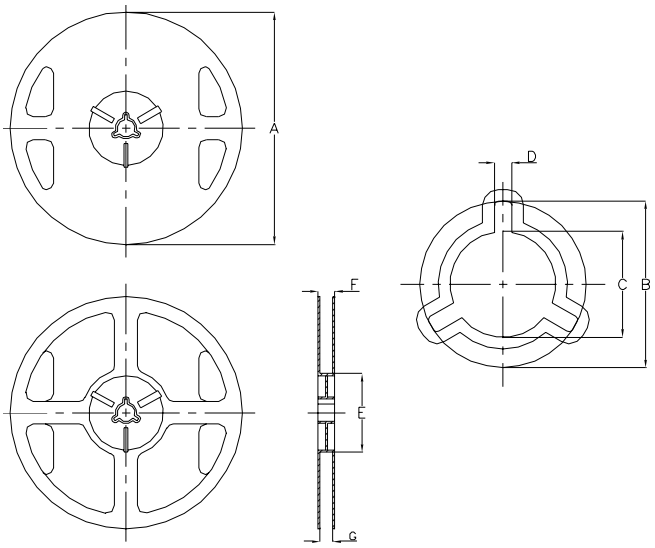
For more information on board mounting, including footprint and stencil recommendation, please refer to application note AN-1136:
http://www.irf.com/technical-info/appnotes/an-1136.pdf
For more information on package inspection techniques, please refer to application note AN-1154:
http://www.irf.com/technical-info/appnotes/an-1154.pdf

PQFN 5x6 Outline "E" Part Marking



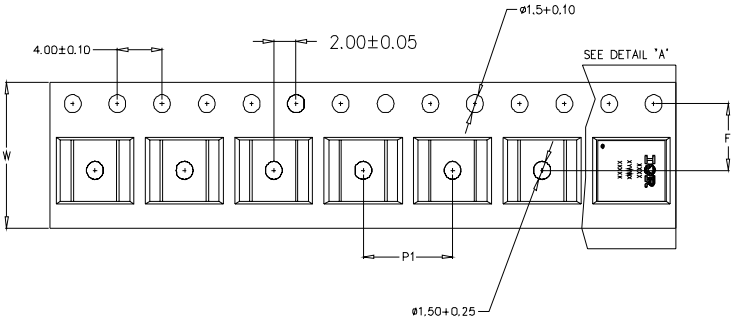
Note: For the most current drawing please refer to IR website at: http://www.irf.com/package/

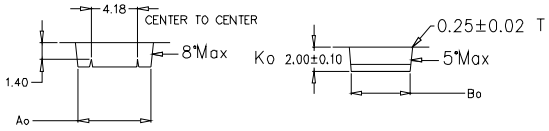
PQFN 5x6 Outline "E" Tape and Reel



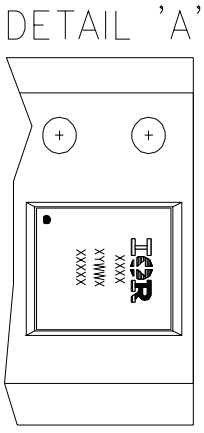
NOTE: Controlling dimensions in mm Std reel quantity is 4000 parts.

REEL DIMENSIONS								
STANDARD OPTION (QTY 4000)					TR2 OPTION (QTY 400)			
	METRIC		IMPERIAL		METRIC		IMPERIAL	
CODE	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX
A	329.5	330.5	12.972	13.011	177.5	178.5	6.988	7.028
B	20.9	21.5	0.823	0.846	20.9	21.5	0.823	0.846
C	12.8	13.5	0.504	0.532	13.2	13.8	0.520	0.543
D	1.7	2.3	0.067	0.091	1.9	2.3	0.075	0.091
E	97	99	3.819	3.898	65	66	2.350	2.598
F	Ref	17.4			Ref	12		
G	13	14.5	0.512	0.571	13	14.5	0.512	0.571





Ao	6.50 ±0.10
Bo	5.28 ±0.10
F	5.50 ±0.05
P1	8.00 ±0.10
W	12.00 +0.30 −0.10



Qualification information†

Qualification level	Consumer†† (per JEDEC JESD47F ††† guidelines)	
Moisture Sensitivity Level	PQFN 5mm x 6mm	MSL1 (per JEDEC J-STD-020D†††)
RoHS compliant	Yes	

† Qualification standards can be found at International Rectifier's web site http://www.irf.com/product-info/reliability

†† Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information: http://www.irf.com/whoto-call/salesrep/

††† Applicable version of JEDEC standard at the time of product release.

Notes:

① Repetitive rating; pulse width limited by max. junction temperature.

② Starting T_J = 25°C, L = 0.22mH, R_G = 50Ω, I_{AS} = 16.2A.

③ Pulse width ≤ 400µs; duty cycle ≤ 2%.

④ R_θ is measured at T_J of approximately 90°C.

⑤ When mounted on 1 inch square 2 oz copper pad on 1.5x1.5 in. board of FR-4 material.

⑥ Calculated continuous current based on maximum allowable junction temperature.

⑦ Current is limited to 16.2A by source bonding technology.

Date	Comment
1/17/2014	• Updated ordering information to reflect the End-Of-Life (EOL) of the mini-reel option (EOL notice #259). • Updated data sheet with the new IR corporate template.

International IOR Rectifier

IR WORLD HEADQUARTERS: 101 N. Sepulveda Blvd., El Segundo, California 90245, USA
To contact International Rectifier, please visit http://www.irf.com/whoto-call/

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Unikeyic Electronics

Global Electronic Components Distributor

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CY15V108QN-20LPXC IPD60R280P7S IPD60R360P7S IR3895MTRPBF IRFP2907PBF IPB042N10N3 G IR2302STRPBF IRF3710PBF TLE6250G V33 FF800R12KE7EHPSA1 IPF012N06NF2SATMA1 TD340N22KOFXPSA1 BSC077N12NS3 G BTS 5210 G IRF7853TRPBF TLS4120D0EPVXUMA1 BSS126IXTSA1 IPW60R018CFD7XKSA1 IRF5210PBF IRFS4227TRLPBF IDH12SG60C IPF010N04NF2SATMA1 IPT60R016CM8XTMA1 IPW60R070CFD7 TLE5046IC-AK-LR CY8C29466-24SXIT EVALPMG1B1DRPTOBO1 IMWH170R450M1XKSA1 IRF7820TRPBF TDA21590